rBOX510-6COM

Robust Din-rail Fanless Embedded System with Intel[®] Atom™ Processor E3827 (1.75 GHz) 6 COM, SATA SSD, DIO, 2 GbE LANs and RTC





















Specifications

Standard Color	Sliver-Black	
Construction	Extruded alumin	num and heavy-duty steel, IP30
CPU	Intel® Atom™ Pr	rocessor E3827 (1.75GHz) Dual Core
System Board	CEM840	
System Memory	4GB Onboard DDR3L/1.35V I/0	O at data rates up to 1066MT/s or 1333MT/s
BIOS	AMI UEFI BIOS	
System I/O Outlet	Serial Port	2 x RS232/422/485 (COM1~2, w/o Isolation), 4 x RS232/422/485 (COM3~6, default w/Isolation) Interface select by software or BIOS Supports Auto Flow Control in RS-485 mode ESD protection 15 KV Magnetic isolation protection 2KV COM 1 & COM 2 speed up to 115.2kbps COM 3 ~ COM 6 serial port speed up to 921.6kbps
	USB	1 x USB 3.0 & 1 x USB 2.0 USB power distribution control by software
	RTC	Battery onboard & Gold capacity onboard (1st backup battery when power shut-down)
	Storage	1 x CF(easy to accessy), 1 x SATA SSD, 1 X m-SATA (via Mini PCle slot)
	LAN	2 10/100/1000 Ethernet Magnetic isolation protection 1.5KV
	VGA	1 x DB15 connector
	Power Input	1 x DC power input with terminal block

Features

- Fanless and cableless design
- Supports Intel[®] Atom[™] processor E3827 (1.75GHz) Dual Core
- Wide temperature operation of -40°C ~ +70°C
- 4 isolated RS-232/422/485 COM ports & 2 RS-232/422/485 COM ports
- 2 isolated 10/100/1000Mbps Ethernet
- 2 watchdog timer
- RTC Battery function
- LED indicators
- 2 wireless (3G/GPRS & Wifi or Zigbee)
- SNMP V1/V2c
- Supports 1 x 2.5" SATA SSD, 1 CompactFlash™, 1 m-SATA
- 1 power paths with terminal block and 12-48VDC
- Supports AXView monitoring software package



▲ Rear view

System I/O Outlet	Wireless	2 x Mini Card	
		a.3G/GPRS or Wifi	
		b.Supports USB interface on 3G/GPRS	
		Supports PCle interface on Wifi	
		1 x SIM socket (Easy to access)	
		3 x Antenna	
		3 x LED	
	DIO	1 isolated DIO (4-IN/ 4-OUT) , DI :	
		Input channels : 4 source type	
		Input voltage: 0 to 30VDC Digital input	
		levels for dry contacts :	
		-Logic level 0 : close to GND	
		-Logic level 1 : open	
		Digital input levels for wet contacts :	
		-Logic level 0 : +10V to +24V (DI to	
		COM-)	
		-Logic level 1 : +3V max.	
		DO:	
		Output channels: 4 sink type	
		Output current : Max. 200mA per	
		channel	
		On-stage voltage: 24VDC nominal,	
		Open collector to 30V	
		Optical isolation protection 2 KV	
Watchdog Timer	2 WDT		
	WDT 1: one step is 1 sec, 255 levels		
	WDT 2 : one step is 250ms, 255 levels		
Expansion Slot	N/A		
System Indicator	System : Power, Alarm, Ready/Active, COM, Wireless (3G/GPRS/Wifi/Zigbee)		
Power Supply	One power pat	h,	
	12~48V DC-In,		
	DC Version: OV	DC Version: OVP, UVP, Reverse protection	

^{*} All specifications and photos are subject to change without notice.

Specifications

Operating Temperature	-40°C ~ 70°C
Storage Temperature	-40°C ~ 85°C
Humidity	5% ~ 95%
Vibration Endurance	5g@10~150Hz, amplitude 0.35mm (operation/storage/transport)
Weight	1.5 kg
Certification	ATEX Certification, Heavy Industrial CE, FCC Part 18, EN50121-4 pre-test (Railway application) UL60950-1 (compliance) UL508 (compliance)
Dimensions	100 x 155 x110mm
EOS Support	Windows 7 Embedded within SNMP function Linux support package Axview

^{*} W.T.: Wide Temperature. All W.T. supported products have to be sorted by AXIOMTEK.
** XPE: Windows® XP Embedded

Ordering Information

Standard	
rB0X510-6C0M-FL1.75G	Robust Din-rail Fanless Embedded system with Intel® Atom TM E3827 1.75 Process Dual Core and 6 COM ports (-40°C \sim +70°C)
Optional	
CompactFlash™	8 GB or above (with W.T. CF)
2.5" SATA SSD or HDD m-SATA WT Wall Mounting Kit	ii) modulo for rPOV corios
VVICEIESS 1317/17PH5 OF VVIT	i) module for rBOX series

Overview

Embedded Systems

Embedded Systems for Transportation

Embedded Field Controllers

Embedded MicroBoxes

Industrial Barebone Systems

Industrial Chassis

Backplanes

Power Supplies

Peripherals & Accessories